

#### **General Description**

The WSD4098DN56 is the highest performance trench Dual N-Ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSD4098DN56 meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

#### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

#### **Product Summery**

BVDSS	RDSON	ID
40V	7.8mΩ	22A

#### **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

#### **DFN5X6C-8-EP2 Pin Configuration**



#### **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit		
Commor	n Ratings				
V <sub>DSS</sub>	Drain-Source Voltage	40	V		
V <sub>GSS</sub>	Gate-Source Voltage	±20	V		
TJ	Maximum Junction Temperature		150	°C	
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C		
I <sub>S</sub>	Diode Continuous Forward Current	T <sub>A</sub> =25°C	11.4	Α	
I <sub>D</sub>		T <sub>A</sub> =25°C	22	А	
	Continuous Drain Current	T <sub>A</sub> =70°C	22		
I <sub>DM</sub> <sup>b</sup>	Pulse Drain Current Tested	T <sub>A</sub> =25°C	88	Α	
P <sub>D</sub>		T. =25°C	25	W	
	Maximum Power Dissipation	T <sub>C</sub> =70°C	10		
R <sub>θJL</sub>	Thermal Resistance-Junction to Lead	Steady State	5	°C/W	
$R_{\theta JA}$		t≤10s	45	°C/W	
	Thermal Resistance-Junction to Ambient	Steady State <sup>b</sup>	90		
l <sub>AS</sub> d	Avalanche Current, Single pulse	L=0.5mH	28	Α	
E <sub>AS</sub> d	Avalanche Energy, Single pulse	L=0.5mH	39.2	mJ	

Note a: Max. continuous current is limited by bonding wire.

Note b: Pulse width limited by max. junction temperature.

Note c : Surface mounted on 1in<sup>2</sup> pad area, steady state t = 999s.

Note d: UIS tested and pulse width limited by maximum junction temperature 150°C (initial temperature T<sub>i</sub>=25°C).



### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

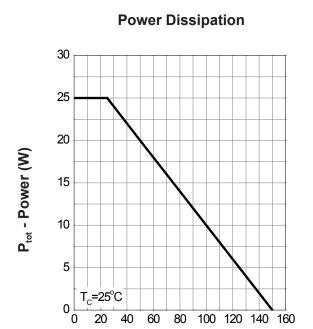
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Static Cha	aracteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V, $I_{DS}$ =250 $\mu$ A	40	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =32V, V <sub>GS</sub> =0V	-	-	1	^
		T <sub>J</sub> =85°C	-	-	30	μΑ
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_{DS}=250\mu A$	1.2	1.8	2.5	V
I <sub>GSS</sub>	Gate Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA
D 0		V <sub>GS</sub> =10V, I <sub>DS</sub> =14A	-	6.8	7.8	mΩ
R <sub>DS(ON)</sub> e	Drain-Source On-state Resistance	V <sub>GS</sub> =4.5V, I <sub>DS</sub> =12 A	-	9.0	11	
Diode Cha	aracteristics	·				
V <sub>SD</sub> e	Diode Forward Voltage	I <sub>SD</sub> =1A, V <sub>GS</sub> =0V	-	0.75	1.1	V
t <sub>rr</sub>	Reverse Recovery Time	1 -20 A dl /dt-100 A / . a	-	23	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$I_{SD}$ =20A, $dI_{SD}/dt$ =100A/ $\mu$ s	-	13	-	nC
Dynamic (	Characteristics <sup>f</sup>		•	•		
$R_G$	Gate Resistance	V <sub>GS</sub> =0V,V <sub>DS</sub> =0V,F=1MHz	-	2.5	-	Ω
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V,	-	1370	1781	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =20V,	-	317	-	
C <sub>rss</sub>	Reverse Transfer Capacitance	Frequency=1.0MHz	-	96	-	
t <sub>d(ON)</sub>	Turn-on Delay Time		-	13.8	-	ns
t <sub>r</sub>	Turn-on Rise Time	$V_{DD}$ =20V, $R_L$ =20 $\Omega$ , $I_{DS}$ =1A,	-	8	-	
t <sub>d(OFF)</sub>	Turn-off Delay Time	$V_{GEN}$ =10V, $R_{G}$ =6 $\Omega$	-	30	-	
t <sub>f</sub>	Turn-off Fall Time		-	21	-	
Gate Char	ge Characteristics f					
Qg	Total Gate Charge	V <sub>DS</sub> =20V, V <sub>GS</sub> =10V, I <sub>DS</sub> =6A	-	23	28	
$Q_g$	Total Gate Charge		-	22	-	
Q <sub>gth</sub>	Threshold Gate Charge	V <sub>DS</sub> =20V, V <sub>GS</sub> =4.5V,	-	2.6	-	nC
Q <sub>gs</sub>	Gate-Source Charge	I <sub>DS</sub> =6A	-	4.7	-	
$Q_{gd}$	Gate-Drain Charge		-	3	-	

Note e : Pulse test ; pulse width≤300µs, duty cycle≤2%.

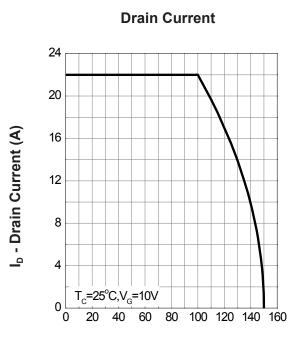
Note f: Guaranteed by design, not subject to production testing.



### **Typical Operating Characteristics**

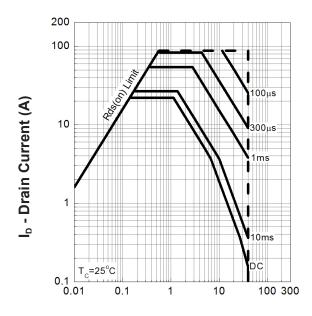


T<sub>i</sub> - Junction Temperature (°C)



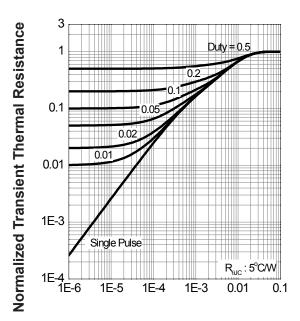
T<sub>i</sub> - Junction Temperature (°C)

### **Safe Operation Area**



V<sub>DS</sub> - Drain - Source Voltage (V)

#### **Thermal Transient Impedance**

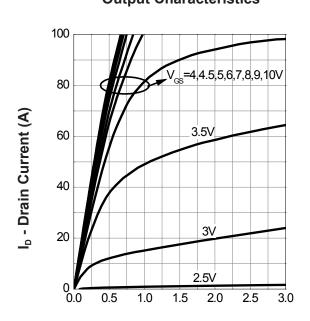


**Square Wave Pulse Duration (sec)** 



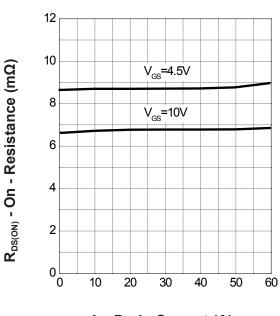
### **Typical Operating Characteristics(Cont.)**

## **Output Characteristics**



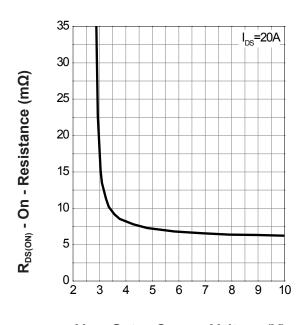
V<sub>DS</sub> - Drain - Source Voltage (V)

#### **Drain-Source On Resistance**



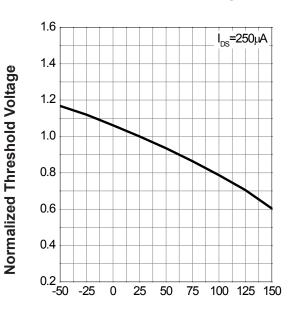
I<sub>D</sub> - Drain Current (A)

#### Gate-Source On Resistance



V<sub>GS</sub> - Gate - Source Voltage (V)

#### **Gate Threshold Voltage**

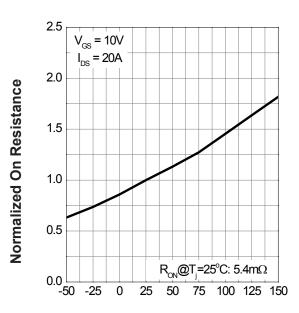


 $T_j$  - Junction Temperature (°C)



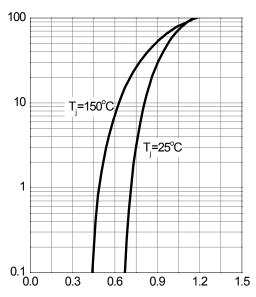
### **Typical Operating Characteristics(Cont.)**

### **Drain-Source On Resistance**



T<sub>j</sub> - Junction Temperature (°C)

# Source-Drain Diode Forward

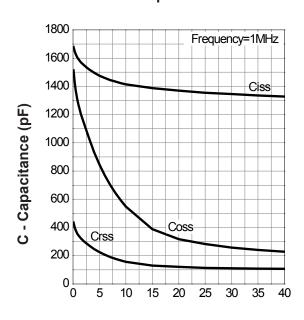


I<sub>s</sub> - Source Current (A)

V<sub>GS</sub> - Gate-source Voltage (V)

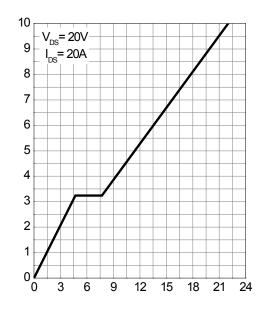
V<sub>SD</sub> - Source - Drain Voltage (V)

#### Capacitance



V<sub>DS</sub> - Drain-Source Voltage (V)

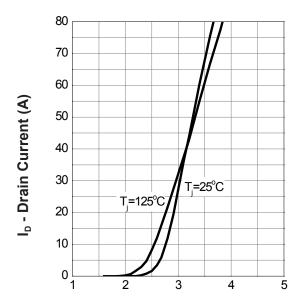
#### **Gate Charge**



Q<sub>G</sub> - Gate Charge (nC)



#### **Transfer Characteristics**



V<sub>GS</sub> - Gate-Source Voltage (V)



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